



## **PRE-HEATER FOR BGA RE-WORK**

Fixture for B.G.A Re-Work System which can hold PCBs for B.G.A Re-work.

850 Series S.M.D Re-work Stations/Systems can be connected at the top and 853 Pre-Heater can be placed below the PCB. Vacuum Pickup Model 381 A can be used to pickup/hold the components.

### **FEATURES**

1. Rapid heating, only 10s to reach 250 °C.
2. Built-in temperature sensor, stable output temperature.
3. Cool or hot air can be selected to pre-heat or cool chips.
4. The preheater can be used with rework stations to process BGA or other flake ICs.

### **SPECIFICATIONS**

Power	460 W
Temperature range	120 °C ~ 250 °C
Air volume	0.18m <sup>3</sup> / min.
Dimensions	100 (L) x 60 (W) x 170 (H) mm
Weight	About 1.0 Kg. (including power cord)

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*\* All Specifications & appearances are subject to change without prior notice.*